

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is and its officers, employees, even if such claim any manner.

SEMICONDUCTOR®

November 2013

FQB44N10 N-Channel QFET® MOSFET

100 V, 43.5 A, 39 m Ω

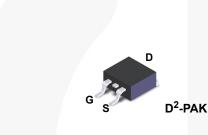
Description

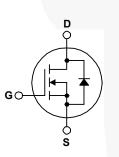
This N-Channel enhancement mode power MOSFET is • 43.5 A, 100 V, $R_{DS(on)}$ = 39 m Ω (Max.) @ V_{GS} = 10 V, produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state $I_D = 21.75 \text{ A}$ Low Gate Charge (Typ. 48 nC) resistance, and to provide superior switching performance • Low Crss (Typ. 85 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

Features

- I_D = 21.75 A

- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

Symbol	Parameter		FQB44N10TM	Unit
V _{DSS}	Drain-Source Voltage		100	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		43.5	A
	- Continuous (T _C = 100°C)		30.8	A
I _{DM}	Drain Current - Pulsed	(Note 1)	174	A
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	530	mJ
I _{AR}	Avalanche Current	(Note 1)	43.5	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	14.6	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns
P _D	Power Dissipation $(T_A = 25^{\circ}C)^*$		3.75	W
	Power Dissipation $(T_C = 25^{\circ}C)$		146	W
	- Derate above 25°C		0.97	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
TL	Maximum lead temperature for soldering,		300	°C
	1/8" from case for 5 seconds.			

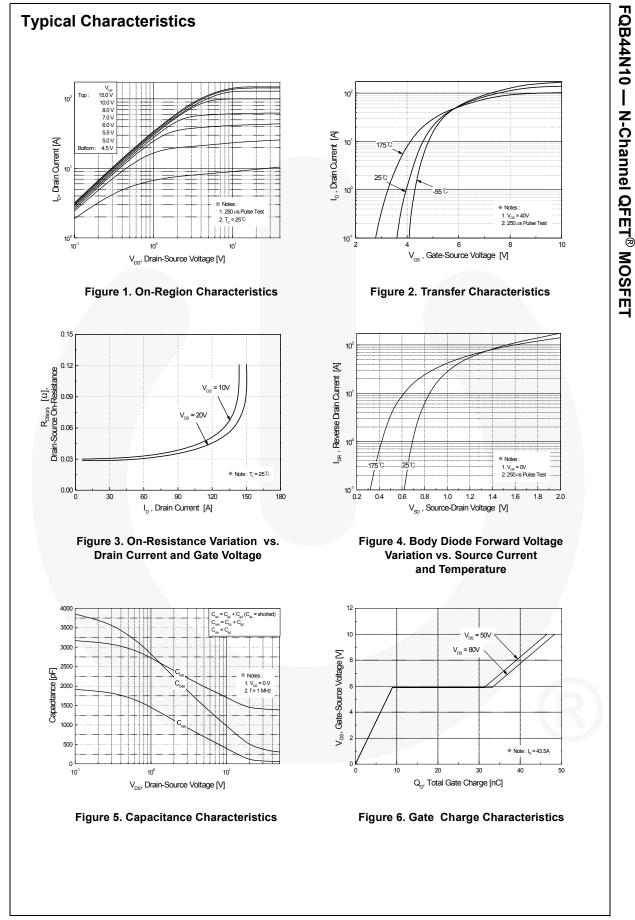
Thermal Characteristics

Symbol	Parameter	FQB44N10TM	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	1.03	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	40]

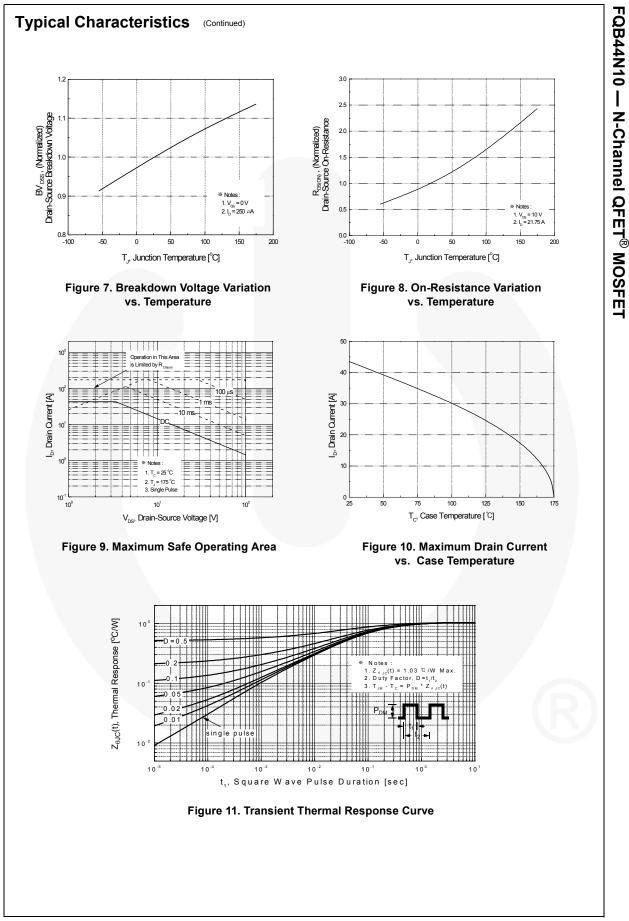
•			0		el Size	Tape W	/idth	Quantity 800 units			
FQB44N10TM FQB44N10		D ² -I	D ² -PAK Tape and Reel 330		0 mm	24 mm					
lectrie	cal Chai	racteris	tics	T _C = 25°0	C unless ot	herwise noted.					
Symbol		Paramet	er			Test Conditions	5	Min.	Тур.	Max.	Unit
Off Cha	racteristi	cs									
BV _{DSS}	Drain-Source Breakdown Voltage			V_{GS} = 0 V, I _D = 250 µA			100			V	
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient			$I_D = 250 \ \mu\text{A}$, Referenced to 25°C				0.1		V/°C	
DSS	Zero Gate Voltage Drain Current			at	V _{DS} = 100 V, V _{GS} = 0 V					1	μA
				V _{DS} = 80 V, T _C = 150°C					10	μA	
GSSF	Gate-Body	Leakage C	urrent,	Forward	V _{GS} =	25 V, V _{DS} = 0 V				100	nA
GSSR	Gate-Body	Leakage C	urrent,	Reverse	V _{GS} =	-25 V, V _{DS} = 0 V				-100	nA
On Cha	racteristi	cs									
/ _{GS(th)}	Gate Three	shold Voltag	е		V _{DS} =	V _{GS} , I _D = 250 μA		2.0		4.0	V
R _{DS(on)}	Static Drai On-Resista				V _{GS} =	10 V, I _D = 21.75 A	\		0.03	0.039	Ω
FS	Forward T	ransconduct	ance		V _{DS} =	40 V, I _D = 21.75 A	`		30		S
-	ic Charac	teristics									
Piss	Input Capa	acitance			V _{DS} = 25 V, V _{GS} = 0 V,				1400	1800	pF
Poss	Output Capacitance		f = 1.0 MHz				425	550	pF		
Srss	Reverse Transfer Capacitance						85	110	pF		
Switchi	ng Chara	cteristics	5								
d(on)	Turn-On Delay Time Turn-On Rise Time		V_{DD} = 50 V, I _D = 43.5 A, R _G = 25 Ω				19	45	ns		
r							190	390	ns		
d(off)	Turn-Off D	elay Time			Ū				90	190	ns
F	Turn-Off F	all Time					(Note 4)	100	210	ns
ζ _g	Total Gate	Charge			V _{DS} =	80 V, I _D = 43.5 A,			48	62	nC
ጋ _{gs}	Gate-Sour	U			V _{GS} =	10 V			9.0		nC
2 _{gd}	Gate-Drair	h Charge					(Note 4)	24		nC
Drain-S	ource Di	ode Char	acteri	istics ar	nd Max	kimum Rating	s				
s	Maximum	Continuous	Drain-S	Source Dic	de Forw	ard Current				43.5	Α
SM	Maximum Pulsed Drain-Source Diode F			Forward Current					174	Α	
/ _{SD}	Drain-Sou	Drain-Source Diode Forward Voltage		V _{GS} = 0 V, I _S = 43.5 A					1.5	V	
rr	Reverse R	ecovery Tim	е		V _{GS} =	0 V, I _S = 43.5 A,			98		ns
ک ^{رر}	Reverse R	ecovery Cha	arge		dI _F / dt = 100 A/μs			360		nC	

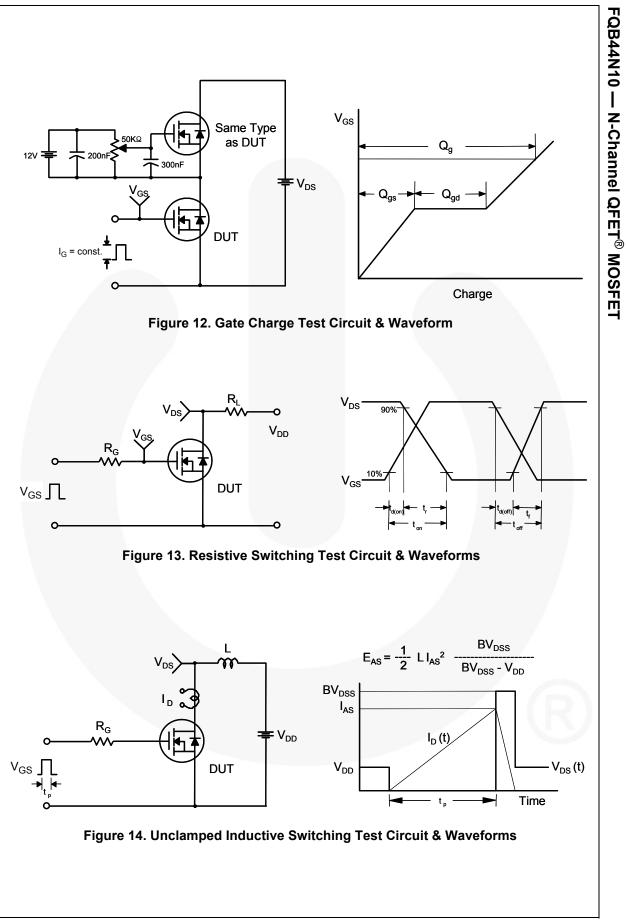
4. Essentially independent of operating temperature.

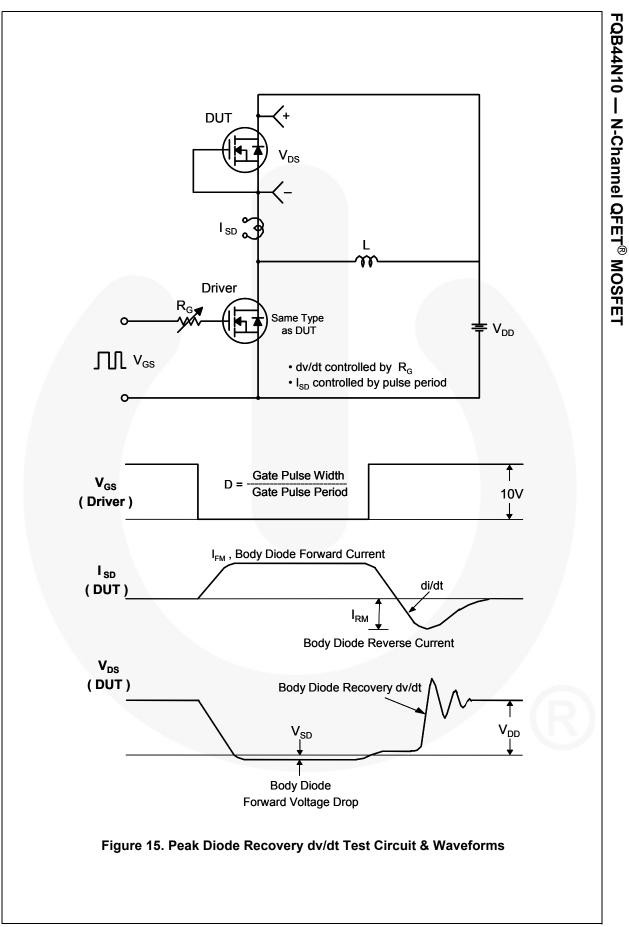
FQB44N10 — N-Channel QFET[®] MOSFET

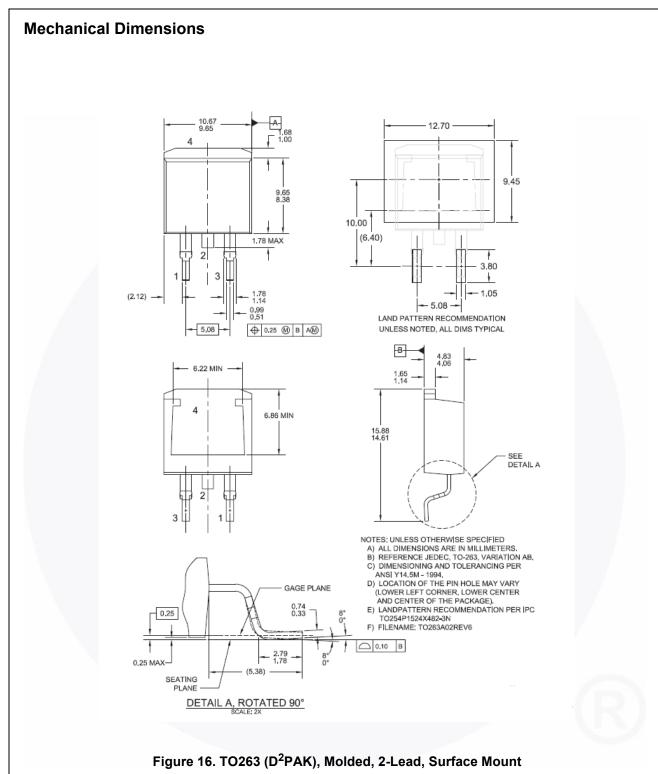


©2000 Fairchild Semiconductor Corporation FQB44N10 Rev. C1









Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TT263-002

FQB44N10 — N-Channel QFET[®] MOSFET



Rev. 166

©2008 Fairchild Semiconductor Corporation FQB44N10 Rev. C1

Bataonoot laontinoation	Troduot otatao	Bolinition				
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.				
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.				
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.				
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.				
		Rev.				

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death a

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

Downloaded from Arrow.com.